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a thin film layer deposited on said substrate, said thin film layer comprising a plurality of recording [track layers] elements; and

a plurality of gluing vias formed between said substrate and said closure and interspersed amongst said plurality of recording [track layers] elements.

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3. (Amended) [A magnetic head] The multi-recording element magnetic head assembly according to claim 1, wherein said recording [track layer] elements comprises at least one of a read [track] element and a write [track] element.

4. (Amended) [A magnetic head] The multi-recording element magnetic head assembly according to claim 3, wherein at least one of said gluing vias are trenched on said side surface of said substrate between said at least one of a read [track] element and a write [track] element.

5. (Amended) [A magnetic head] The multi-recording element magnetic head assembly according to claim 1 wherein said gluing vias are photolithographically defined and subsequently trenched on said side surfaces.

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6. (Twice Amended) A multi-recording element magnetic tape head assembly for reading from and writing to a magnetic tape moving across the head, comprising:  
a substrate having a gap side surface;  
a closure having a gap side surface that opposes and is separated from said gap side surface of said substrate by a gap;  
a thin film layer deposited on said gap side surface of said substrate in said gap, wherein said thin film layer comprises a plurality of recording [tracks] elements;  
a plurality of gluing vias formed between said substrate and said closure; and  
adhesive in said gap and said gluing vias.

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7. (Amended) [A magnetic tape head] The multi-recording element magnetic tape head assembly according to claim 6, wherein said recording [track] layer comprises at least one of a read [track] element and a write [track] element.

8. (Amended) [A magnetic tape head] The multi-recording element magnetic tape head assembly according to claim 8 wherein at least one of said gluing vias are trenched on said

side surface of said substrate between said at least one of a read [track] element and a write [track] element.

10. (Amended) [A magnetic tape head] The multi-recording element magnetic tape head assembly according to said claim 6 wherein said gluing vias are photolithographically defined and subsequently trenched on at least one of said gap side surfaces of said substrate and said closure.

19. (Amended) The [magnetic head] multi-recording element magnetic head assembly of Claim 1 formed in accordance with the method of Claim 11.

20. (Amended) The [magnetic head] multi-recording element magnetic head assembly of Claim 1 wherein at least a portion of said plurality of gluing vias intersects said C-core.

21. (Amended) A multi-track magnetic head assembly, comprising:  
a plurality of [tracks] recording elements;  
a core;  
at least one gluing via located between two adjacent [tracks] recording elements of the plurality of [tracks] recording elements, said at least one gluing via in contact with, and extending from, said core; and  
an adhesive inserted into said core and said at least one gluing via.

22. (Amended) The multi-recording element magnetic tape head assembly of Claim 6, wherein the plurality of gluing vias are trenched in the closure gap side surface and are absent the substrate gap side surface.

23. (Amended) The multi-recording element magnetic tape head assembly of Claim 6, wherein the plurality of gluing vias are trenched in the substrate gap side surface and are absent the closure gap side surface.

24. (Amended) The multi-recording element magnetic tape head assembly of Claim 6, wherein the plurality of gluing vias are trenched in the substrate gap side surface and the closure gap side surface.